# E·XFL

# Intel - EPF10K200EFC672-2 Datasheet



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#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

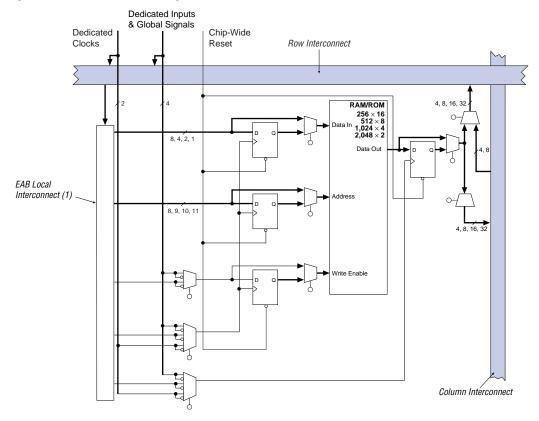
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

## Details

Details	
Product Status	Obsolete
Number of LABs/CLBs	1248
Number of Logic Elements/Cells	9984
Total RAM Bits	98304
Number of I/O	470
Number of Gates	513000
Voltage - Supply	2.3V ~ 2.7V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	672-BBGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf10k200efc672-2

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



#### Figure 4. FLEX 10KE Device in Single-Port RAM Mode

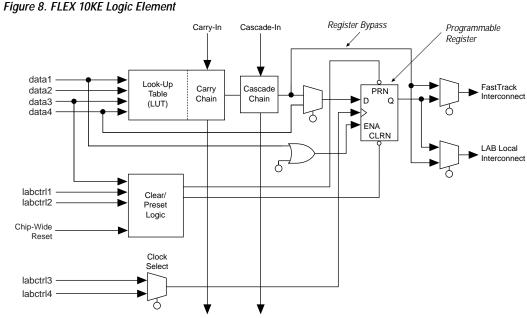
#### Note:

(1) EPF10K30E, EPF10K50E, and EPF10K50S devices have 88 EAB local interconnect channels; EPF10K100E, EPF10K130E, EPF10K200E, and EPF10K200S devices have 104 EAB local interconnect channels.

EABs can be used to implement synchronous RAM, which is easier to use than asynchronous RAM. A circuit using asynchronous RAM must generate the RAM write enable signal, while ensuring that its data and address signals meet setup and hold time specifications relative to the write enable signal. In contrast, the EAB's synchronous RAM generates its own write enable signal and is self-timed with respect to the input or write clock. A circuit using the EAB's self-timed RAM must only meet the setup and hold time specifications of the global clock. Each LAB provides four control signals with programmable inversion that can be used in all eight LEs. Two of these signals can be used as clocks, the other two can be used for clear/preset control. The LAB clocks can be driven by the dedicated clock input pins, global signals, I/O signals, or internal signals via the LAB local interconnect. The LAB preset and clear control signals can be driven by the global signals, I/O signals, or internal signals via the LAB local interconnect. The global control signals are typically used for global clock, clear, or preset signals because they provide asynchronous control with very low skew across the device. If logic is required on a control signal, it can be generated in one or more LE in any LAB and driven into the local interconnect of the target LAB. In addition, the global control signals can be generated from LE outputs.

# Logic Element

The LE, the smallest unit of logic in the FLEX 10KE architecture, has a compact size that provides efficient logic utilization. Each LE contains a four-input LUT, which is a function generator that can quickly compute any function of four variables. In addition, each LE contains a programmable flipflop with a synchronous clock enable, a carry chain, and a cascade chain. Each LE drives both the local and the FastTrack Interconnect routing structure (see Figure 8).



The programmable flipflop in the LE can be configured for D, T, JK, or SR operation. The clock, clear, and preset control signals on the flipflop can be driven by global signals, general-purpose I/O pins, or any internal logic. For combinatorial functions, the flipflop is bypassed and the output of the LUT drives the output of the LE.

The LE has two outputs that drive the interconnect: one drives the local interconnect and the other drives either the row or column FastTrack Interconnect routing structure. The two outputs can be controlled independently. For example, the LUT can drive one output while the register drives the other output. This feature, called register packing, can improve LE utilization because the register and the LUT can be used for unrelated functions.

The FLEX 10KE architecture provides two types of dedicated high-speed data paths that connect adjacent LEs without using local interconnect paths: carry chains and cascade chains. The carry chain supports high-speed counters and adders and the cascade chain implements wide-input functions with minimum delay. Carry and cascade chains connect all LEs in a LAB as well as all LABs in the same row. Intensive use of carry and cascade chains can reduce routing flexibility. Therefore, the use of these chains should be limited to speed-critical portions of a design.

# Carry Chain

The carry chain provides a very fast (as low as 0.2 ns) carry-forward function between LEs. The carry-in signal from a lower-order bit drives forward into the higher-order bit via the carry chain, and feeds into both the LUT and the next portion of the carry chain. This feature allows the FLEX 10KE architecture to implement high-speed counters, adders, and comparators of arbitrary width efficiently. Carry chain logic can be created automatically by the Altera Compiler during design processing, or manually by the designer during design entry. Parameterized functions such as LPM and DesignWare functions automatically take advantage of carry chains.

Carry chains longer than eight LEs are automatically implemented by linking LABs together. For enhanced fitting, a long carry chain skips alternate LABs in a row. A carry chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from oddnumbered LAB to odd-numbered LAB. For example, the last LE of the first LAB in a row carries to the first LE of the third LAB in the row. The carry chain does not cross the EAB at the middle of the row. For instance, in the EPF10K50E device, the carry chain stops at the eighteenth LAB and a new one begins at the nineteenth LAB. Figure 9 shows how an *n*-bit full adder can be implemented in n + 1 LEs with the carry chain. One portion of the LUT generates the sum of two bits using the input signals and the carry-in signal; the sum is routed to the output of the LE. The register can be bypassed for simple adders or used for an accumulator function. Another portion of the LUT and the carry chain logic generates the carry-out signal, which is routed directly to the carry-in signal of the next-higher-order bit. The final carry-out signal is routed to an LE, where it can be used as a general-purpose signal.

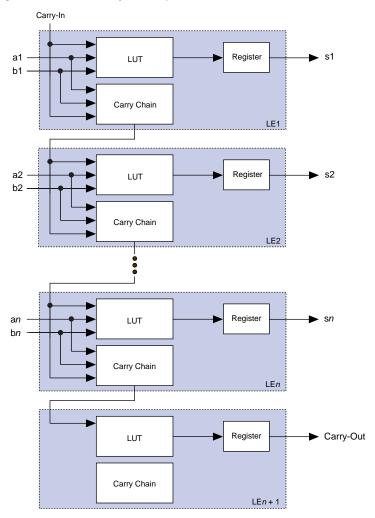


Figure 9. FLEX 10KE Carry Chain Operation (n-Bit Full Adder)

#### Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in are inputs to a four-input LUT. The Altera Compiler automatically selects the carry-in or the DATA3 signal as one of the inputs to the LUT. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. Either the register or the LUT can be used to drive both the local interconnect and the FastTrack Interconnect routing structure at the same time.

The LUT and the register in the LE can be used independently (register packing). To support register packing, the LE has two outputs; one drives the local interconnect, and the other drives the FastTrack Interconnect routing structure. The DATA4 signal can drive the register directly, allowing the LUT to compute a function that is independent of the registered signal; a three-input function can be computed in the LUT, and a fourth independent signal can be registered. Alternatively, a four-input function can be generated, and one of the inputs to this function can be used to drive the register. The register in a packed LE can still use the clock enable, clear, and preset signals in the LE. In a packed LE, the register can drive the FastTrack Interconnect routing structure while the LUT drives the local interconnect, or vice versa.

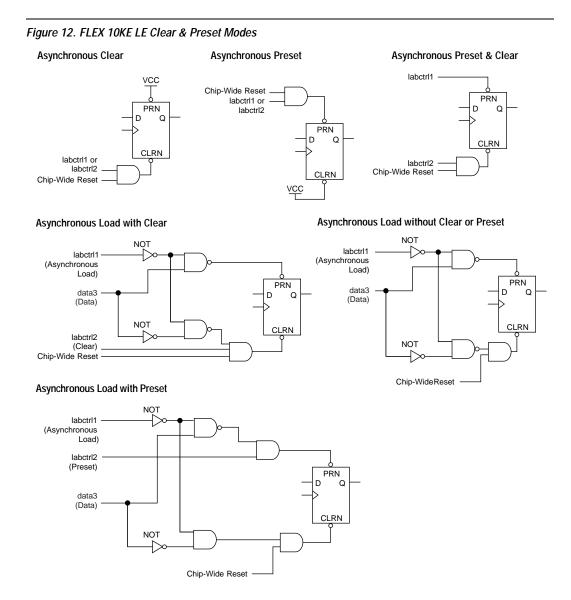
## Arithmetic Mode

The arithmetic mode offers 2 three-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT computes a three-input function; the other generates a carry output. As shown in Figure 11 on page 22, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three signals: a, b, and carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports simultaneous use of the cascade chain.

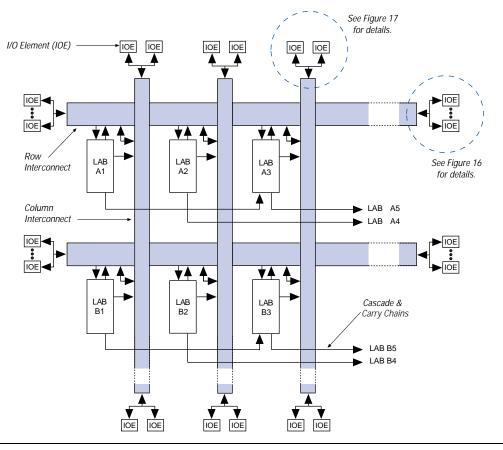
## **Up/Down Counter Mode**

The up/down counter mode offers counter enable, clock enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Use 2 three-input LUTs: one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals without using the LUT resources.

In addition to the six clear and preset modes, FLEX 10KE devices provide a chip-wide reset pin that can reset all registers in the device. Use of this feature is set during design entry. In any of the clear and preset modes, the chip-wide reset overrides all other signals. Registers with asynchronous presets may be preset when the chip-wide reset is asserted. Inversion can be used to implement the asynchronous preset. Figure 12 shows examples of how to setup the preset and clear inputs for the desired functionality.



# Altera Corporation





# I/O Element

An IOE contains a bidirectional I/O buffer and a register that can be used either as an input register for external data that requires a fast setup time, or as an output register for data that requires fast clock-to-output performance. In some cases, using an LE register for an input register will result in a faster setup time than using an IOE register. IOEs can be used as input, output, or bidirectional pins. For bidirectional registered I/O implementation, the output register should be in the IOE, and the data input and output enable registers should be LE registers placed adjacent to the bidirectional pin. The Altera Compiler uses the programmable inversion option to invert signals from the row and column interconnect automatically where appropriate. Figure 15 shows the bidirectional I/O registers. When dedicated inputs drive non-inverted and inverted peripheral clears, clock enables, and output enables, two signals on the peripheral control bus will be used.

Tables 8 and 9 list the sources for each peripheral control signal, and show how the output enable, clock enable, clock, and clear signals share 12 peripheral control signals. The tables also show the rows that can drive global signals.

Table 8. Peripheral Bus Sources for EPF10K30E, E	PF10K50E & EPF10K50S Devi	ices
Peripheral Control Signal	EPF10K30E	EPF10K50E EPF10K50S
OEO	Row A	Row A
OE1	Row B	Row B
OE2	Row C	Row D
OE3	Row D	Row F
OE4	Row E	Row H
OE5	Row F	Row J
CLKENA0/CLK0/GLOBAL0	Row A	Row A
CLKENA1/OE6/GLOBAL1	Row B	Row C
CLKENA2/CLR0	Row C	Row E
CLKENA3/OE7/GLOBAL2	Row D	Row G
CLKENA4/CLR1	Row E	Row I
CLKENA5/CLK1/GLOBAL3	Row F	Row J

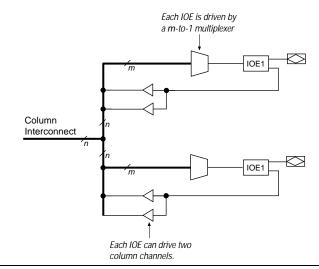
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Column-to-IOE Connections

When an IOE is used as an input, it can drive up to two separate column channels. When an IOE is used as an output, the signal is driven by a multiplexer that selects a signal from the column channels. Two IOEs connect to each side of the column channels. Each IOE can be driven by column channels via a multiplexer. The set of column channels is different for each IOE (see Figure 17).



The values for m and n are provided in Table 11.



### Table 11 lists the FLEX 10KE column-to-IOE interconnect resources.

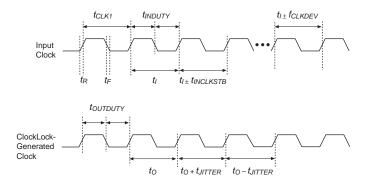
Table 11. FLEX 10	KE Column-to-IOE Interconne	ect Resources
Device	Channels per Column (n)	Column Channels per Pin (m)
EPF10K30E	24	16
EPF10K50E EPF10K50S	24	16
EPF10K100E	24	16
EPF10K130E	32	24
EPF10K200E EPF10K200S	48	40

## ClockLock & ClockBoost Timing Parameters

For the ClockLock and ClockBoost circuitry to function properly, the incoming clock must meet certain requirements. If these specifications are not met, the circuitry may not lock onto the incoming clock, which generates an erroneous clock within the device. The clock generated by the ClockLock and ClockBoost circuitry must also meet certain specifications. If the incoming clock meets these requirements during configuration, the ClockLock and ClockBoost circuitry will lock onto the clock during configuration. The circuit will be ready for use immediately after configuration. Figure 19 shows the incoming and generated clock specifications.

#### Figure 19. Specifications for Incoming & Generated Clocks

The  $t_l$  parameter refers to the nominal input clock period; the  $t_0$  parameter refers to the nominal output clock period.



Symbol	Parameter	Condition	Min	Тур	Max	Unit
t <sub>R</sub>	Input rise time				5	ns
t <sub>F</sub>	Input fall time				5	ns
t <sub>INDUTY</sub>	Input duty cycle		40		60	%
f <sub>CLK1</sub>	Input clock frequency (ClockBoost clock multiplication factor equals 1)		25		75	MHz
f <sub>CLK2</sub>	Input clock frequency (ClockBoost clock multiplication factor equals 2)		16		37.5	MHz
f <sub>CLKDEV</sub>	Input deviation from user specification in the MAX+PLUS II software (1)				25,000 (2)	PPM
t <sub>INCLKSTB</sub>	Input clock stability (measured between adjacent clocks)				100	ps
t <sub>LOCK</sub>	Time required for ClockLock or ClockBoost to acquire lock (3)				10	μs
t <sub>JITTER</sub>	Jitter on ClockLock or ClockBoost-	$t_{INCLKSTB} < 100$			250	ps
	generated clock (4)	$t_{INCLKSTB} < 50$			200 (4)	ps
toutduty	Duty cycle for ClockLock or ClockBoost-generated clock		40	50	60	%

#### Notes to tables:

- (1) To implement the ClockLock and ClockBoost circuitry with the MAX+PLUS II software, designers must specify the input frequency. The Altera software tunes the PLL in the ClockLock and ClockBoost circuitry to this frequency. The f<sub>CLKDEV</sub> parameter specifies how much the incoming clock can differ from the specified frequency during device operation. Simulation does not reflect this parameter.
- (2) Twenty-five thousand parts per million (PPM) equates to 2.5% of input clock period.
- (3) During device configuration, the ClockLock and ClockBoost circuitry is configured before the rest of the device. If the incoming clock is supplied during configuration, the ClockLock and ClockBoost circuitry locks during configuration because the t<sub>LOCK</sub> value is less than the time required for configuration.
- (4) The t<sub>ITTER</sub> specification is measured under long-term observation. The maximum value for t<sub>ITTER</sub> is 200 ps if t<sub>INCLKSTB</sub> is lower than 50 ps.

# I/O Configuration

This section discusses the peripheral component interconnect (PCI) pull-up clamping diode option, slew-rate control, open-drain output option, and MultiVolt I/O interface for FLEX 10KE devices. The PCI pull-up clamping diode, slew-rate control, and open-drain output options are controlled pin-by-pin via Altera software logic options. The MultiVolt I/O interface is controlled by connecting  $V_{CCIO}$  to a different voltage than  $V_{CCINT}$ . Its effect can be simulated in the Altera software via the **Global Project Device Options** dialog box (Assign menu).

Table 17. 32-	Bit IDCOD	E for FLEX 10KE Devices	Note (1)							
Device		IDCODE (32 Bits)								
	Version (4 Bits)	Part Number (16 Bits)	Manufacturer's Identity (11 Bits)	<b>1 (1 Bit)</b> (2)						
EPF10K30E	0001	0001 0000 0011 0000	00001101110	1						
EPF10K50E EPF10K50S	0001	0001 0000 0101 0000	00001101110	1						
EPF10K100E	0010	0000 0001 0000 0000	00001101110	1						
EPF10K130E	0001	0000 0001 0011 0000	00001101110	1						
EPF10K200E EPF10K200S	0001	0000 0010 0000 0000	00001101110	1						

#### Notes:

(1) The most significant bit (MSB) is on the left.

(2) The least significant bit (LSB) for all JTAG IDCODEs is 1.

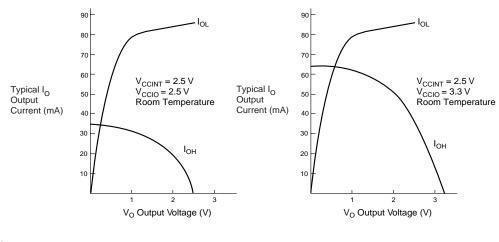
FLEX 10KE devices include weak pull-up resistors on the JTAG pins.



For more information, see the following documents:

- Application Note 39 (IEEE Std. 1149.1 (JTAG) Boundary-Scan Testing in Altera Devices)
- BitBlaster Serial Download Cable Data Sheet
- ByteBlasterMV Parallel Port Download Cable Data Sheet
- Jam Programming & Test Language Specification





#### Figure 23. Output Drive Characteristics of FLEX 10KE Devices Note (1)

#### Note:

(1) These are transient (AC) currents.

# **Timing Model**

The continuous, high-performance FastTrack Interconnect routing resources ensure predictable performance and accurate simulation and timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and therefore have unpredictable performance.

Device performance can be estimated by following the signal path from a source, through the interconnect, to the destination. For example, the registered performance between two LEs on the same row can be calculated by adding the following parameters:

- LE register clock-to-output delay (*t*<sub>CO</sub>)
- Interconnect delay (t<sub>SAMEROW</sub>)
- **LE** look-up table delay  $(t_{LUT})$
- **LE** register setup time  $(t_{SU})$

The routing delay depends on the placement of the source and destination LEs. A more complex registered path may involve multiple combinatorial LEs between the source and destination LEs.

Symbol	-1 Spee	d Grade	-2 Spee	-2 Speed Grade		ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>DIN2IOE</sub>		1.8		2.4		2.9	ns
t <sub>DIN2LE</sub>		1.5		1.8		2.4	ns
t <sub>DIN2DATA</sub>		1.5		1.8		2.2	ns
t <sub>DCLK2IOE</sub>		2.2		2.6		3.0	ns
t <sub>DCLK2LE</sub>		1.5		1.8		2.4	ns
t <sub>SAMELAB</sub>		0.1		0.2		0.3	ns
t <sub>SAMEROW</sub>		2.0		2.4		2.7	ns
t <sub>SAMECOLUMN</sub>		0.7		1.0		0.8	ns
t <sub>DIFFROW</sub>		2.7		3.4		3.5	ns
t <sub>TWOROWS</sub>		4.7		5.8		6.2	ns
t <sub>LEPERIPH</sub>		2.7		3.4		3.8	ns
t <sub>LABCARRY</sub>		0.3		0.4		0.5	ns
t <sub>LABCASC</sub>		0.8		0.8		1.1	ns

Symbol	-1 Spee	ed Grade	-2 Spee	-2 Speed Grade		ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>DRR</sub>		8.0		9.5		12.5	ns
t <sub>INSU</sub> (3)	2.1		2.5		3.9		ns
t <sub>INH</sub> (3)	0.0		0.0		0.0		ns
<sup>t</sup> оитсо <sup>(3)</sup>	2.0	4.9	2.0	5.9	2.0	7.6	ns
t <sub>INSU</sub> (4)	1.1		1.5		-		ns
t <sub>INH</sub> (4)	0.0		0.0		-		ns
t <sub>оитсо</sub> (4)	0.5	3.9	0.5	4.9	-	-	ns
t <sub>PCISU</sub>	3.0		4.2		-		ns
t <sub>PCIH</sub>	0.0		0.0		-		ns
t <sub>PCICO</sub>	2.0	6.0	2.0	7.5	_	-	ns

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Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABDATA1</sub>		1.7		2.0		2.7	ns
t <sub>EABDATA1</sub>		0.6		0.7		0.9	ns
t <sub>EABWE1</sub>		1.1		1.3		1.8	ns
t <sub>EABWE2</sub>		0.4		0.4		0.6	ns
t <sub>EABRE1</sub>		0.8		0.9		1.2	ns
t <sub>EABRE2</sub>		0.4		0.4		0.6	ns
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns
t <sub>EABCO</sub>		0.3		0.3		0.5	ns
t <sub>EABBYPASS</sub>		0.5		0.6		0.8	ns
t <sub>EABSU</sub>	0.9		1.0		1.4		ns
t <sub>EABH</sub>	0.4		0.4		0.6		ns
t <sub>EABCLR</sub>	0.3		0.3		0.5		ns
t <sub>AA</sub>		3.2		3.8		5.1	ns
t <sub>WP</sub>	2.5		2.9		3.9		ns
t <sub>RP</sub>	0.9		1.1		1.5		ns
t <sub>WDSU</sub>	0.9		1.0		1.4		ns
t <sub>WDH</sub>	0.1		0.1		0.2		ns
t <sub>WASU</sub>	1.7		2.0		2.7		ns
t <sub>WAH</sub>	1.8		2.1		2.9		ns
t <sub>RASU</sub>	3.1		3.7		5.0		ns
t <sub>RAH</sub>	0.2		0.2		0.3		ns
t <sub>WO</sub>		2.5		2.9		3.9	ns
t <sub>DD</sub>		2.5		2.9		3.9	ns
t <sub>EABOUT</sub>		0.5		0.6		0.8	ns
t <sub>EABCH</sub>	1.5		2.0		2.5		ns
t <sub>EABCL</sub>	2.5		2.9		3.9		ns

# FLEX 10KE Embedded Programmable Logic Devices Data Sheet

Symbol	-1 Spee	d Grade	-2 Spee	ed Grade	-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>DIN2IOE</sub>		2.8		3.5		4.4	ns
t <sub>DIN2LE</sub>		0.7		1.2		1.6	ns
t <sub>DIN2DATA</sub>		1.6		1.9		2.2	ns
t <sub>DCLK2IOE</sub>		1.6		2.1		2.7	ns
t <sub>DCLK2LE</sub>		0.7		1.2		1.6	ns
t <sub>SAMELAB</sub>		0.1		0.2		0.2	ns
t <sub>SAMEROW</sub>		1.9		3.4		5.1	ns
t <sub>SAMECOLUMN</sub>		0.9		2.6		4.4	ns
t <sub>DIFFROW</sub>		2.8		6.0		9.5	ns
t <sub>TWOROWS</sub>		4.7		9.4		14.6	ns
t <sub>LEPERIPH</sub>		3.1		4.7		6.9	ns
t <sub>LABCARRY</sub>		0.6		0.8		1.0	ns
t <sub>LABCASC</sub>		0.9		1.2		1.6	ns

Table 57. EPF10K130E External Timing Parameters       Notes (1), (2)									
Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		d Grade	Unit		
	Min	Max	Min	Max	Min	Max			
t <sub>DRR</sub>		9.0		12.0		16.0	ns		
t <sub>INSU</sub> (3)	1.9		2.1		3.0		ns		
t <sub>INH</sub> (3)	0.0		0.0		0.0		ns		
<b>t</b> оитсо (3)	2.0	5.0	2.0	7.0	2.0	9.2	ns		
t <sub>INSU</sub> (4)	0.9		1.1		-		ns		
t <sub>INH</sub> (4)	0.0		0.0		-		ns		
tоитсо <i>(4)</i>	0.5	4.0	0.5	6.0	-	-	ns		
t <sub>PCISU</sub>	3.0		6.2		-		ns		
t <sub>PCIH</sub>	0.0		0.0		-		ns		
t <sub>PCICO</sub>	2.0	6.0	2.0	6.9	-	-	ns		

Symbol	-1 Speed Grade		-2 Spee	-2 Speed Grade		d Grade	Unit
	Min	Max	Min	Max	Min	Мах	
t <sub>EABWCOMB</sub>	6.7		8.1		10.7		ns
t <sub>EABWCREG</sub>	6.6		8.0		10.6		ns
t <sub>EABDD</sub>		4.0		5.1		6.7	ns
t <sub>EABDATACO</sub>		0.8		1.0		1.3	ns
t <sub>EABDATASU</sub>	1.3		1.6		2.1		ns
t <sub>EABDATAH</sub>	0.0		0.0		0.0		ns
t <sub>EABWESU</sub>	0.9		1.1		1.5		ns
t <sub>EABWEH</sub>	0.4		0.5		0.6		ns
t <sub>EABWDSU</sub>	1.5		1.8		2.4		ns
t <sub>EABWDH</sub>	0.0		0.0		0.0		ns
t <sub>EABWASU</sub>	3.0		3.6		4.7		ns
t <sub>EABWAH</sub>	0.4		0.5		0.7		ns
t <sub>EABWO</sub>		3.4		4.4		5.8	ns

 Table 63. EPF10K200E Device Interconnect Timing Microparameters
 Note (1)

Symbol	-1 Spee	ed Grade	-2 Spee	d Grade	-3 Spee	ed Grade	Unit	
	Min	Max	Min	Max	Min	Max		
t <sub>DIN2IOE</sub>		4.2		4.6		5.7	ns	
t <sub>DIN2LE</sub>		1.7		1.7		2.0	ns	
t <sub>DIN2DATA</sub>		1.9		2.1		3.0	ns	
t <sub>DCLK2IOE</sub>		2.5		2.9		4.0	ns	
t <sub>DCLK2LE</sub>		1.7		1.7		2.0	ns	
t <sub>SAMELAB</sub>		0.1		0.1		0.2	ns	
t <sub>SAMEROW</sub>		2.3		2.6		3.6	ns	
t <sub>SAMECOLUMN</sub>		2.5		2.7		4.1	ns	
t <sub>DIFFROW</sub>		4.8		5.3		7.7	ns	
t <sub>TWOROWS</sub>		7.1		7.9		11.3	ns	
t <sub>LEPERIPH</sub>		7.0		7.6		9.0	ns	
t <sub>LABCARRY</sub>		0.1		0.1		0.2	ns	
t <sub>LABCASC</sub>		0.9		1.0		1.4	ns	

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABAA</sub>		3.7		5.2		7.0	ns
t <sub>EABRCCOMB</sub>	3.7		5.2		7.0		ns
t <sub>EABRCREG</sub>	3.5		4.9		6.6		ns
t <sub>EABWP</sub>	2.0		2.8		3.8		ns
t <sub>EABWCCOMB</sub>	4.5		6.3		8.6		ns
t <sub>EABWCREG</sub>	5.6		7.8		10.6		ns
t <sub>EABDD</sub>		3.8		5.3		7.2	ns
t <sub>EABDATACO</sub>		0.8		1.1		1.5	ns
t <sub>EABDATASU</sub>	1.1		1.6		2.1		ns
t <sub>EABDATAH</sub>	0.0		0.0		0.0		ns
t <sub>EABWESU</sub>	0.7		1.0		1.3		ns
t <sub>EABWEH</sub>	0.4		0.6		0.8		ns
t <sub>EABWDSU</sub>	1.2		1.7		2.2		ns
t <sub>EABWDH</sub>	0.0		0.0		0.0		ns
t <sub>EABWASU</sub>	1.6		2.3		3.0		ns
t <sub>EABWAH</sub>	0.9		1.2		1.8		ns
t <sub>EABWO</sub>		3.1		4.3		5.9	ns

Table 70. EPF10	K50S Device	Interconnec	t Timing Mi	croparamete	e <b>rs</b> Note	(1)	
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>DIN2IOE</sub>		3.1		3.7		4.6	ns
t <sub>DIN2LE</sub>		1.7		2.1		2.7	ns
t <sub>DIN2DATA</sub>		2.7		3.1		5.1	ns
t <sub>DCLK2IOE</sub>		1.6		1.9		2.6	ns
t <sub>DCLK2LE</sub>		1.7		2.1		2.7	ns
t <sub>SAMELAB</sub>		0.1		0.1		0.2	ns
t <sub>SAMEROW</sub>		1.5		1.7		2.4	ns
t <sub>SAMECOLUMN</sub>		1.0		1.3		2.1	ns
t <sub>DIFFROW</sub>		2.5		3.0		4.5	ns
t <sub>TWOROWS</sub>		4.0		4.7		6.9	ns
t <sub>LEPERIPH</sub>		2.6		2.9		3.4	ns
t <sub>LABCARRY</sub>		0.1		0.2		0.2	ns
t <sub>LABCASC</sub>		0.8		1.0		1.3	ns

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Table 77. EPF10K200S Device Interconnect Timing Microparameters (Part 2 of 2)       Note (1)							
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Мах	Min	Max	Min	Max	
t <sub>LABCASC</sub>		0.5		1.0		1.4	ns

 Table 78. EPF10K200S External Timing Parameters
 Note (1)

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>DRR</sub>		9.0		12.0		16.0	ns
t <sub>INSU</sub> (2)	3.1		3.7		4.7		ns
t <sub>INH</sub> (2)	0.0		0.0		0.0		ns
t <sub>оитсо</sub> (2)	2.0	3.7	2.0	4.4	2.0	6.3	ns
t <sub>INSU</sub> (3)	2.1		2.7		-		ns
t <sub>INH</sub> (3)	0.0		0.0		-		ns
<b>t</b> оитсо <sup>(3)</sup>	0.5	2.7	0.5	3.4	-	-	ns
t <sub>PCISU</sub>	3.0		4.2		-		ns
t <sub>PCIH</sub>	0.0		0.0		-		ns
t <sub>PCICO</sub>	2.0	6.0	2.0	8.9	-	_	ns

Table 79. EPF10K200S External Bidirectional Timing Parameters Note (1) Symbol -1 Speed Grade -2 Speed Grade -3 Speed Grade Unit Min Max Min Max Min Max t<sub>INSUBIDIR</sub> (2) 2.3 3.4 4.4 ns 0.0 t<sub>INHBIDIR</sub> (2) 0.0 0.0 ns tINSUBIDIR (3) 3.3 4.4 \_ ns t<sub>INHBIDIR</sub> (3) 0.0 0.0 \_ ns toutcobidir (2) 2.0 3.7 2.0 4.4 2.0 6.3 ns t<sub>XZBIDIR</sub> (2) 6.9 7.6 9.2 ns t<sub>ZXBIDIR</sub> (2) 5.9 6.6 \_ ns toutcobidir (3) 0.5 2.7 0.5 3.4 \_ \_ ns t<sub>XZBIDIR</sub> (3) 6.9 7.6 9.2 ns t<sub>ZXBIDIR</sub> (3) 6.6 5.9 \_ ns

# Notes to tables:

(1) All timing parameters are described in Tables 24 through 30 in this data sheet.

(2) This parameter is measured without the use of the ClockLock or ClockBoost circuits.

(3) This parameter is measured with the use of the ClockLock or ClockBoost circuits.

#### **Altera Corporation**

Additionally, the Altera software offers several features that help plan for future device migration by preventing the use of conflicting I/O pins.

Table 81. I/O Counts for FLEX 10KA & FLEX 10KE Devices						
FLEX 10	KA	FLEX 10KE				
Device	I/O Count	Device	I/O Count			
EPF10K30AF256	191	EPF10K30EF256	176			
EPF10K30AF484	246	EPF10K30EF484	220			
EPF10K50VB356	274	EPF10K50SB356	220			
EPF10K50VF484	291	EPF10K50EF484	254			
EPF10K50VF484	291	EPF10K50SF484	254			
EPF10K100AF484	369	EPF10K100EF484	338			

**Configuration Schemes** 

The configuration data for a FLEX 10KE device can be loaded with one of five configuration schemes (see Table 82), chosen on the basis of the target application. An EPC1, EPC2, or EPC16 configuration device, intelligent controller, or the JTAG port can be used to control the configuration of a FLEX 10KE device, allowing automatic configuration on system power-up.

Multiple FLEX 10KE devices can be configured in any of the five configuration schemes by connecting the configuration enable (nCE) and configuration enable output (nCEO) pins on each device. Additional FLEX 10K, FLEX 10KA, FLEX 10KE, and FLEX 6000 devices can be configured in the same serial chain.

Table 82. Data Sources for FLEX 10KE Configuration					
Configuration Scheme	Data Source				
Configuration device	EPC1, EPC2, or EPC16 configuration device				
Passive serial (PS)	BitBlaster, ByteBlasterMV, or MasterBlaster download cables, or serial data source				
Passive parallel asynchronous (PPA)	Parallel data source				
Passive parallel synchronous (PPS)	Parallel data source				
JTAG	BitBlaster or ByteBlasterMV download cables, or microprocessor with a Jam STAPL file or JBC file				